

Zero Drift, Precision Instrumentation Amplifier with Digitally Programmable Gain

DESCRIPTION

The LTC[®]6915 is a precision programmable gain instrumentation amplifier. The gain can be programmed to 0, 1, 2, 4, 8, 16, 32, 64, 128, 256, 512, 1024, 2048, or 4096 through a parallel or serial interface. The CMRR is typically 125dB with a single 5V supply with any programmed gain. The offset is below 10μ V with a temperature drift of less than 50nV/°C.

The LTC6915 uses charge balanced sampled data techniques to convert a differential input voltage into a single ended signal that is in turn amplified by a zero-drift operational amplifier.

The differential inputs operate from rail-to-rail and the single-ended output swings from rail-to-rail. The LTC6915 can be used in single power supply applications as low as 2.7V, or with dual ±5V supplies. The LTC6915 is available in a 16-lead SSOP package and a 12-lead DFN surface mount package.

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FEATURES

- 14 Levels of Programmable Gain
- 125dB CMRR Independent of Gain
- Gain Accuracy 0.1% (Typ)
- Maximum Offset Voltage of $10\mu V$
- Maximum Offset Voltage Drift: 50nV/°C
- Rail-to-Rail Input and Output
- Parallel or Serial (SPI) Interface for Gain Setting
- Supply Operation: 2.7V to ±5.5V
- Typical Noise: 2.5µV_{P-P} (0.01Hz to 10Hz)
- 16-Lead SSOP and 12-Lead DFN Packages

APPLICATIONS

- Thermocouple Amplifiers
- Electronic Scales
- Medical Instrumentation
- Strain Gauge Amplifier
- High Resolution Data Acquisition

TYPICAL APPLICATION



Differential Bridge Amplifier with Gain Programmed through the Serial Interface



ABSOLUTE MAXIMUM RATINGS (Note 1)

Total Supply Voltage (V ⁺ to V ⁻)	11V
Input Current	±10mA
$ V_{IN}^+ - V_{REF} $	5.5V
V _{IN} ⁻ – V _{REF}	5.5V
V ⁺ – V _{DGND}	5.5V
$ V_{\text{DGND}} - V^{-} $	5.5V
Digital Input Voltage	⁻ to V+
Operating Temperature Range	
LTC6915C	o 70°C

LTC69151	40°C to 85°C
Libertian Tomporature	40 0 10 120 0
Junction remperature	
(GN Package)	150°C
(DFN Package)	125°C
Storage Temperature	
(GN Package)	–65°C to 150°C
(DFN Package)	65°C to 125°C
Lead Temperature (Soldering 10 sec)	300°C

PACKAGE/ORDER INFORMATION



Consult LTC Marketing for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS The • denotes the specifications which apply over the full operating

temperature range, otherwise specifications are at $T_A = 25^{\circ}C$.

SYMBOL	PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS		
V ⁺ = 3V, V ⁻ = 0V, V _{REF} = 200 mV									
	Gain Error (Note 2)	A _V = 1 (R _L =10k)	•	-0.075	0	0.075	%		
	Gain Error (Note 2)	$A_V = 2 \text{ to } 32 \text{ (R}_L = 10 \text{k)}$	•	-0.5	0	0.5	%		
	Gain Error (Note 2)	A _V = 64 to 1024 (R _L = 10k)	•	-0.6	-0.1	0.6	%		
	Gain Error (Note 2)	A _V = 2048, 4096 (R _L = 10k)	•	-1	-0.2	1.0	%		
	Gain Nonlinearity	A _V = 1	•		3	15	ppm		
V _{0S}	Input Offset Voltage (Note 3)	V _{CM} = 200mV			-3	±10	μV		
	Average Input Offset Drift (Note 3)	$T_A = -40^{\circ}C \text{ to } 85^{\circ}C$ $T_A = 85^{\circ}C \text{ to } 125^{\circ}C$	•			±50 ±100	nV/°C nV/°C		
IB	Average Input Bias Current (Note 4)	V _{CM} = 1.2V	•		5	10	nA		
l _{os}	Average Input Offset Current (Note 4)	V _{CM} = 1.2V	•		1.5	3	nA		
e _n	Input Noise Voltage	DC to 10Hz			2.5		μν _{Ρ-Ρ}		



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SYMBOL	PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS	
$V^+ = 3V, V^-$	= 0V, V _{REF} = 200 mV	L		1			
CMRR	Common Mode Rejection Ratio	$\begin{array}{l} A_V = 1024, V_{CM} = 0V \ to \ 3V, LTC6915C \\ A_V = 1024, V_{CM} = 0.1V \ to \ 2.9V, LTC6915I \\ A_V = 1024, V_{CM} = 0V \ to \ 3V, LTC6915I \\ A_V = 1024, V_{CM} = 0.1V \ to \ 2.9V, LTC6915H \\ A_V = 1024, V_{CM} = 0V \ to \ 2.97V, LTC6915H \end{array}$	• • • •	100 100 95 100 85	119 119 119		dB dB dB dB dB
PSRR	Power Supply Rejection Ratio (Note 5)	V _S = 2.7V to 6V		110	116		dB
	Output Voltage Swing High (Referenced to V ⁻)	Sourcing 200µA Sourcing 2mA	•	2.95 2.75	2.98 2.87		V V
	Output Voltage Swing Low (Referenced to V ⁻)	Sinking 200µA Sinking 2mA	•		18 130	50 300	mV mV
	Supply Current, Parallel Mode	No Load at OUT, V _{CM} = 200mV	•		0.88	1.3	mA
	Supply Current, Serial Mode (Note 6)	No Load at OUT, Capacitive Load at D_{OUT} (C _L) = 15pF, Continuous CLK Frequency = 4MHz, \overline{CS} = LOW, Gain Control Code = 0001	•		1.1	1.65	mA
	Supply Current Shutdown	V _{SHDN} = 2.7V (Hardware Shutdown) V _{SHDN} = 1V, Gain Control Code = 0000 (Software Shutdown)	•		1 125	4 180	μΑ μΑ
	SHDN Input High			2.7			V
	SHDN Input Low		•			1	V
	SHDN and HOLD_THRU Input Current (Note 2)		•			5	μA
	Internal Op Amp Gain Bandwidth				200		kHz
	Slew Rate				0.2		V/µs
	Internal Sampling Frequency				3		kHz
$V^+ = 5V, V^-$	= 0V, V _{REF} = 200mV		1				
	Gain Error (Note 2)	$A_V = 1 (R_L = 10k)$	•	-0.075	0	0.075	%
	Gain Error (Note 2)	$A_V = 2 \text{ to } 32 (R_L = 10k)$	•	-0.5	0	0.5	%
	Gain Error (Note 2)	A _V = 64 to 1024 (R _L = 10k)	•	-0.6	-0.1	0.6	%
	Gain Error (Note 2)	A _V = 2048, 4096 (R _L = 10k)	•	1	-0.2	1	%
	Gain Nonlinearity	A _V = 1	•		3	15	ppm
V _{OS}	Input Offset Voltage (Note 3)	V _{CM} = 200mV			-3	±10	μV
	Average Input Offset Drift (Note 3)	$T_A = -40^{\circ}C \text{ to } 85^{\circ}C$ $T_A = 85^{\circ}C \text{ to } 125^{\circ}C$	•			±50 ±100	nV/°C nV/°C
	Average Input Bias Current (Note 4)	V _{CM} = 1.2V	•		5	10	nA
l _{OS}	Average Input Offset Current (Note 4)	V _{CM} = 1.2V	•		1.5	3	nA
CMRR	Common Mode Rejection Ratio	$\begin{array}{l} A_V = 1024, V_{CM} = 0V \ to \ 5V, LTC6915C \\ A_V = 1024, V_{CM} = 0.1V \ to \ 4.9V, LTC6915I \\ A_V = 1024, V_{CM} = 0V \ to \ 5V, LTC6915I \\ A_V = 1024, V_{CM} = 0.1V \ to \ 4.9V, LTC6915H \\ A_V = 1024, V_{CM} = 0V \ to \ 4.97V, LTC6915H \end{array}$	• • • •	105 105 95 100 85	125 125 125		dB dB dB dB dB
PSRR	Power Supply Rejection Ratio (Note 5)	V _S = 2.7V to 6V	•	110	116		dB
	Output Voltage Swing High	Sourcing 200µA Sourcing 2mA	•	4.95 4.80	4.99 4.93		V V
	Output Voltage Swing Low	Sinking 200µA Sinking 2mA	•		17 120	50 300	mV mV



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SYMBOL	PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
$V^{+} = 5V, V^{-}$	= 0V, V _{REF} = 200mV					•	
	Supply Current, Parallel Mode	No Load at OUT, V _{CM} = 200mV			0.95	1.48	mA
	Supply Current, Serial Mode (Note 6)	No Load at OUT, Capacitive Load at D_{OUT} (C _L) = 15pF, C <u>ontinuous</u> CLK Frequency = 4MHz, \overline{CS} = LOW, Gain Control Code = 0001	•		1.4	2	mA
	Supply Current, Shutdown	V _{SHDN} = 4.5V (Hardware Shutdown) V _{SHDN} = 1V, Gain Control Code = 0000 (Software Shutdown)	•		2 135	10 200	μΑ μΑ
	SHDN Input High		•	4.5			V
	SHDN Input Low					1	V
	SHDN and HOLD_THRU Input Current (Note 2)					5	μA
	Internal Op Amp Gain Bandwidth				200		kHz
	Slew Rate				0.2		V/µs
	Internal Sampling Frequency				3		kHz
$V^+ = 5V, V^-$	= -5V, V _{REF} = 0V						
	Gain Error (Note 2)	$A_V = 1 (R_L = 10k)$	•	-0.075	0	0.075	%
	Gain Error (Note 2)	A _V = 2 to 32 (R _L = 10k)	•	-0.5	0	0.5	%
	Gain Error (Note 2)	A _V = 64 to 1024 (R _L = 10k)	•	-0.6	-0.1	0.6	%
	Gain Error (Note 2)	A _V = 2048, 4096 (R _L = 10k)	•	-1	-0.2	1	%
	Gain Nonlinearity	A _V = 1	•		3	15	ppm
V _{OS}	Input Offset Voltage (Note 3)	V _{CM} = 0mV			5	±20	μV
	Average Input Offset Drift (Note 3)	$T_A = -40^{\circ}C \text{ to } 85^{\circ}C$ $T_A = 85^{\circ}C \text{ to } 125^{\circ}C$	•			±50 ±100	nV/°C nV/°C
l _{os}	Average Input Bias Current (Note 4)	V _{CM} = 1V	•		4	10	nA
	Average Input Offset Current (Note 4)	V _{CM} = 1V	•		1.5	3	nA
CMRR	Common Mode Rejection Ratio	$\begin{array}{l} A_V = 1024, V_{CM} = -5V \ \text{to} \ 5V, LTC6915C \\ A_V = 1024, V_{CM} = -4.9V \ \text{to} \ 4.9V, LTC6915I \\ A_V = 1024, V_{CM} = -5V \ \text{to} \ 5V, LTC6915I \\ A_V = 1024, V_{CM} = -4.9V \ \text{to} \ 4.9V, LTC6915H \\ A_V = 1024, V_{CM} = -5V \ \text{to} \ 4.97V, LTC6915H \end{array}$	• • • •	105 105 100 100 90	123 123 123		dB dB dB dB dB
PSRR	Power Supply Rejection Ratio (Note 5)	V _S = 2.7V to 11V	٠	110	116		dB
	Output Voltage Swing High	Sourcing 200µA Sourcing 2mA	•	4.97 4.90	4.99 4.96		V V
	Output Voltage Swing Low	Sinking 200µA Sinking 2mA	•		-4.98 -4.90	-4.92 -4.70	mV mV
	Supply Current, Parallel Mode	No Load, V _{CM} = 0mV	•		1.1	1.6	mA
	Supply Current, Serial Mode (Note 6)	No Load at OUT, Capacitive Load at D_{OUT} (C _L) = 15pF, Continuous CLK Frequency = 4MHz, \overline{CS} = LOW, Gain Control Code = 0001	•		1.73	2.48	mA
	Supply Current, Shutdown	V _{SHDN} = 4V (Hardware Shutdown) V _{SHDN} = 1V, Gain Control Code = 0000 (Software Shutdown)	•		160	25 240	μΑ μΑ
	SHDN Input High		•	4			V
	SHDN Input Low					1	V



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SYMBOL	PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS						
$V^+ = 5V, V^- = -5V, V_{REF} = 0V$												
	SHDN and HOLD_THRU Input Current (Note 2)					5	μA					
	Internal Op Amp Gain Bandwidth				200		kHz					
	Slew Rate				0.2		V/µs					
	Internal Sampling Frequency				3		kHz					
Digital I/O, I	All Digital I/O Voltage Referenced to DGND											
VIH	Digital Input High Voltage			2.0			V					
VIL	Digital Input Low Voltage					0.8	V					
V _{OH}	Digital Output High Voltage	Sourcing 500µA		V ⁺ – 0.3			V					
V _{OL}	Digital Output Low Voltage	Sinking 500µA				0.3	V					
	Digital Input Leakage	$V^+ = 5V, V^- = -5V, V_{IN} = 0V \text{ to } 5V$				±2	μA					
Timing, V+ =	= 2.7V to 4.5V, V^- = 0V (Note 7)											
t ₁	D _{IN} Valid to CLK Setup			60			ns					
t ₂	D _{IN} Valid to CLK Hold			0			ns					
t ₃	CLK Low			100			ns					
t4	CLK High			100			ns					
t ₅	CS/LD Pulse Width			60			ns					
t ₆	LSB CLK to CS/LD			60			ns					
t ₇	CS/LD Low to CLK			30			ns					
t ₈	D _{OUT} Output Delay	C _L = 15pF				125	ns					
tg	CLK Low to CS/LD Low			0			ns					
Timing, V ⁺ =	4.5V to 5.5V, V ⁻ = 0V (Note 7)						. <u> </u>					
t ₁	D _{IN} Valid to CLK Setup			30			ns					
t ₂	D _{IN} Valid to CLK Hold			0			ns					
t ₃	CLK Low			50			ns					
t ₄	CLK High			50			ns					
t ₅	CS/LD Pulse Width			40			ns					
t ₆	LSB CLK to CS/LD			40			ns					
t ₇	CS/LD Low to CLK			20			ns					
t ₈	D _{OUT} Output Delay	C _L = 15pF				85	ns					
t ₉	CLK Low to CS/LD Low			0			ns					
Timing, Dua	I \pm 4.5V to \pm 5.5V Supplies (Note 7)	· · ·										
t ₁	D _{IN} Valid to CLK Setup			30			ns					
t ₂	D _{IN} Valid to CLK Hold			0			ns					
t ₃	CLK High			50			ns					
t ₄	CLK Low			50			ns					
t ₅	CS/LD Pulse Width			40			ns					
t ₆	LSB CLK to CS/LD			40			ns					
t ₇	CS/LD Low to CLK			20			ns					
t ₈	D _{OUT} Output Delay	C _L = 15pF				85	ns					
t ₉	CLK Low to CS/LD Low			0			ns					



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ELECTRICAL CHARACTERISTICS

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: These parameters are tested at $\pm 5V$ supply; at 3V and 5V supplies they are guaranteed by design.

Note 3: These parameters are guaranteed by design. Thermocouple effects preclude measurement of these voltage levels in high speed automatic test systems. V_{OS} is measured to a limit set by test equipment capability.

Note 4: If the total source resistance is less than 10k, no DC errors result from the input bias current or mismatch of the input bias currents or the mismatch of the resistances connected to IN^- and IN^+ .

Note 5: The PSRR measurement accuracy depends on the proximity of the power supply bypass capacitor to the device under test. Because of this, the PSRR is 100% tested to relaxed limits at final test. However, their values are guaranteed by design to meet the data sheet limits.

Note 6: Supply current is dependent on the clock frequency. A higher clock frequency results in higher supply current.

Note 7: Guaranteed by design, not subject to test.

TYPICAL PERFORMANCE CHARACTERISTICS







Common Mode 2 $V_{\rm S} = 5V$ $V_{REF} = 0.2V$ $T_A = 25^{\circ}C$ 0 -2 NPUT OFFSET VOLTAGE (μV) -4 = 4096-6 -8 256 Av -10 -12 16 Av -14 -16

Input Offset Voltage vs Input



Input Offset Voltage vs Input Common Mode



Input Offset Voltage vs Input Common Mode



Input Offset Voltage vs Input Common Mode





TYPICAL PERFORMANCE CHARACTERISTICS



Error Due to Input R_S Mismatch vs Input Common Mode



Offset Voltage vs Temperature 15 10 INPUT OFFSET VOLTAGE (µV) $V_{\rm S} = \pm 5V$ 5 0 $V_{\rm S} = 5V$ $V_{S} = 3V$ -5 -1075 -50 -25 0 25 50 100 125 TEMPERATURE (°C) 6915 G13



Error Due to Input R_S Mismatch vs Input Common Mode



V_{OS} vs REF (Pin 13) 2 $V_{IN^+} = V_{IN^-} = REF$ $A_{V} = 16$ T_A = 25°C -3 V_{0S} (µV) -8 1 $V_{\rm S} = 5V$ $V_{\rm S} = 3V$ -13 -18 2.0 3.0 0 0.5 1.0 1.5 2.5 3.5 4.0 V_{REF} (V) 6915 G14

Error Due to Input R_S vs Input Common Mode



Error Due to Input R_S Mismatch vs Input Common Mode



V_{OS} vs REF (Pin 13)





TYPICAL PERFORMANCE CHARACTERISTICS



CMRR vs Frequency



Input Referred Noise in **10Hz Bandwidth**



Low Gain Settling Time vs Settling Accuracy

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TYPICAL PERFORMANCE CHARACTERISTICS



PIN FUNCTIONS (DFN/GN Packages)

IN⁻ (Pin 1/Pin 2): Inverting Analog Input.

SHDN (Pin 1 GN Package Only): Shutdown Pin. The IC is shut down when SHDN is tied to V⁺. An internal current source pulls this pin to V⁻ when floating.

IN+ (Pin 2/Pin 3): Noninverting Analog Input.

V⁻ (Pin 3/Pin 4): Negative Supply.

CS(D0) (Pin 4/Pin 6): TTL Level Input. When in serial control mode, this pin is the chip select input (active low); in parallel control mode, this pin is the LSB of the parallel gain control code.

 $D_{IN}(D1)$ (Pin 5/Pin 7): TTL Level Input. When in serial control mode, this pin is the serial input data; in parallel mode, this pin is the second LSB of the parallel gain control code.

HOLD_THRU (Pin 5 GN Package Only): TTL Level Input for Parallel Control Mode. When HOLD_THRU is high, the parallel data is latched in an internal D-latch.

CLK(D2) (Pin 6/Pin 8): TTL Level Input. When in serial control mode, this pin is the clock of the serial interface; in parallel mode, this pin is the third LSB of the parallel gain control code.

D_{OUT}(D3) (Pin 7/Pin 9): TTL Level Input. When in serial control mode, this pin is the output of the serial data; in parallel mode, this pin is the MSB of the 4-bit parallel gain

control code. In parallel mode operation, if the data in to D_{OUT} (Pin 9) is from a voltage source greater than V⁺ (Pin 12), then connect a resistor between the voltage source and D_{OUT} to limit the current into Pin 9 to 5mA or less.

DGND (Pin 8/Pin 10): Digital Ground.

PARALLEL_SERIAL (Pin 9/Pin 11): Interface Selection Input. When tied to V⁺, the interface is in parallel mode, i.e., the PGA gain is defined by the parallel codes (D3 ~ D0), i.e., $\overline{CS}(D0)$, DATA(D1), CLK(D2), and D_{OUT}(D3). When PARALLEL_SERIAL pin is tied to V⁻, the PGA gain is set by the serial interface.

REF (Pin 10/Pin 13): Voltage Reference for PGA output.

OUT (Pin 11/Pin 15): Amplifier Output. The typical current sourcing/sinking of the OUT pin is 1mA. For minimum gain error, the load resistance should be 1k or greater (refer to the Output Voltage Swing vs Output Current and Gain Error vs Load Resistance in the Typical Performance Characteristics section).

V⁺ (Pin 12/Pin 16): Positive Supply.

SENSE (Pin 14 GN Package Only): Sense Pin. When the PGA drives a low resistance load and the interconnect resistance between the OUT pin and the load is not negligible, tying the SENSE pin as close as possible to the load can improve the gain accuracy.



BLOCK DIAGRAMS



sn6915 6915fas



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Timing Diagram of the Serial Interface t₆ CLK 🖛 tg → D3 D0 D2 D1 D7 Π4 D3 DIN t5 CS/LD t₈ D2 D0 D4 D3 D1 D7 • • D4 D3 D_{OUT} PREVIOUS BYTE CURRENT BYTE 6915 TD

TIMING DIAGRAM

OPERATION

Theory of Operation (Refer to Block Diagrams)

The LTC6915 uses an internal capacitor (C_S) to sample a differential input signal riding on a DC common mode voltage (the sampling rate is 3kHz and the input switch-on resistance is 1k to 2k, depending on the power supply voltage). This capacitor's charge is transferred to a second internal hold capacitor (C_H) translating the common mode voltage of the input differential signal to that of REF pin. The resulting signal is amplified by a zero-drift op amp in the noninverting configuration. Gain control within the amplifier occurs by switching resistors from a matched resistor array. The LTC6915 has 14 levels of gain, controlled by the parallel or serial interface. A feedback capacitor C_F helps to reduce the switching noise. Due to the input sampling, an LTC6915 may produce aliasing errors for input signals greater than 1.5kHz (one half the 3kHz sampling frequency). However, if the input signal is bandlimited to less than 1.5kHz then an LTC6915 is useful as instrumentation or as a differential to single-ended AC amplifier with programmable gain.

Parallel Interface

As shown in Figure 1, connecting PARALLEL_SERIAL to V⁺ allows the gain control code to be set through the parallel lines (D3, D2, D1, D0). When HOLD_THRU is low



(referenced to DGND) or floating, the parallel gain control bits ($D_3 \sim D0$) directly control the PGA gain. When HOLD_THRU is high, the parallel gain control bits are read into and held by a 4-bit latch. Any change at D3 ~ D0 will not affect the PGA gain when HOLD_THRU is high. Note that the DFN12 package does not have the HOLD_THRU pin. Instead, it is tied to DGND internally. The D_{OUT}(D3) pin is bidirectional (output in serial mode, input in parallel mode). In parallel mode, the voltage at D_{OUT}(D3) cannot exceed V⁺; otherwise, large currents can be injected to V⁺ through the parasitic diode (see Figure 2). Connecting a 10k resistor at the D_{OUT}(D3) pin if parallel mode is selected (see Figure 1) is recommended for current limiting.

Serial Interface

Connecting PARALLEL_SERIAL to V⁻ allows the gain control code to be set through the serial interface. When \overline{CS} is low, the serial data on D_{IN} is shifted into an 8-bit shiftregister on the rising edge of the clock, with the MSB transferred first (see Figure 3). Serial data on D_{OUT} is shifted out on the clock's falling edge. A high \overline{CS} will load the 4 LSBs of the shift-register into a 4-bit D-latch, which are the gain control bits. The clock is disabled internally when \overline{CS} is pulled high. Note: CLK must be low before \overline{CS} is pulled low to avoid an extra internal clock pulse.

OPERATION

 D_{OUT} is always active in serial mode (never tri-stated). This simplifies the daisy chaining of the multiple devices. D_{OUT} cannot be "wire-or" to other SPI outputs. In addition, D_{OUT} does not return to zero at the end of transmission, i.e. when \overline{CS} is pulled high.

A LTC6915 may be daisy-chained with other LTC6915s or other devices having serial interfaces by connecting the

 D_{OUT} to the D_{IN} of the next chip while CLK and \overline{CS} remain common to all chips in the daisy chain. The serial data is clocked to all the chips then the \overline{CS} signal is pulled high to update all of them simultaneously. Figure 4 shows an example of two LTC6915s in a daisy chained SPI configuration.







Figure 2. Bidirectional Nature of $D_{OUT}/D3$ Pin



Figure 3. Diagram of Serial Interface (MSB First Out)





OPERATION



Figure 4. 2 PGAs in a Daisy Chain

The amplifier's gain is set as follows:

D3, D2, D1, D0	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101~ 1111
Gain	0	1	2	4	8	16	32	64	128	256	512	1024	2048	4096

Input Voltage Range

The input common mode voltage range of the LTC6915 is rail-to-rail. However, the following equation limits the size of the differential input voltage:

$$V^{-} \le (V_{IN}^{+} - V_{IN}^{-}) + V_{REF} \le V^{+} - 1.3$$

Where V_{IN}^+ and V_{IN}^- are the voltage of the differential input pins, V⁺ and V⁻ are the positive and negative supply voltages respectively and V_{REF} is the voltage of REF pin. In addition, V_{IN}^+ and V_{IN}^- must not exceed the power supply voltages, i.e.,

$$V^{-} < V_{IN}^{+} < V^{+}$$
 and $V^{-} < V_{IN}^{-} < V^{+}$

± 5 Volt Operation

When using the LTC6915 with supplies over 5.5V, care must be taken to limit the maximum difference between any of the input pins (IN^+ or IN^-) and the REF pin to 5.5V, i.e.,

$$|V_{IN}^+ - V_{REF}| < 5.5$$
 and $|V_{IN}^- - V_{REF}| < 5.5$

If not, the device will be damaged. For example, if rail-torail input operation is desired when the supplies are at \pm 5V, the REF pin should be 0, \pm 0.5V. As a second example, if the V⁺ pin is 10V, and the V⁻ and REF pins are at 0, the inputs should not exceed 5.5V.



OPERATION

Settling Time

The sampling rate is 3kHz and the input sampling period during which C_{S} is charged to the input differential voltage, V_{IN} , is approximately 150µs. First assume that on each input sampling period, C_S is charged fully to V_{IN} . Since C_S $= C_H$ (= 1000pF), a change in the input will settle to N bits of accuracy at the op amp noninverting input after N clock cycles or 333µs(N). The settling time at the OUT pin is also affected by the internal op amp. Since the gain bandwidth of the internal op amp is typically 200kHz, the settling time is dominated by the switched-capacitor front end for gains below 100 (see the Low Gain Settling Time vs Settling Accuracy and the Settling Time vs Gain graphs in the Typical Performance Characteristics section). In addition, the worst case settling time after a device-enable (active low on Pin 1 of a GN package) is equal to the settling due to the gain plus the input settling time $(333\mu s \cdot N)$. For example, if an LTC6915 is enabled with a logic high on Pin 1 then, the maximum settling time to 10 bits of accuracy (0.1%) and a gain equal to 100 is 8.33ms ([333µs • 1024] + 5ms).

Input Current

Whenever the differential input V_{IN} changes, C_H must be charged up to the new input voltage via C_S . This results in an input charging current during each input sampling period. Eventually, C_H and C_S will reach V_{IN} and ideally, the input current would go to zero for DC inputs.

In reality, there are additional parasitic capacitors which disturb the charge on C_S every cycle even if V_{IN} is a DC voltage. For example, the parasitic bottom plate capacitor on C_S must be charged from the voltage on the REF pin to the voltage on the IN⁻ pin every cycle. The resulting input charging current decays exponentially during each input sampling period with a time constant equal to $R_S C_S$. If the voltage disturbance due to these currents settles before the end of the sampling period, there will be no errors due to source resistance or the source resistance mismatch between IN⁺ and IN⁻. With R_S less than 10k, no DC errors occur due to input current mismatch.

In the Typical Performance Characteristics section of this data sheet, there are curves showing the additional error from non-zero source resistance in the inputs. If there are no large capacitors across the inputs, the amplifier is less sensitive to source resistance and source resistance mismatch. When large capacitors are placed across the inputs, the input charging currents are placed across the inputs. The input charging currents described above result in larger DC errors, especially with source resistor mismatches.

Power Supply Bypassing

In a dual supply operation, connect a 0.1μ F bypass capacitor from each power supply pin (V⁺ and V⁻) to an analog round plance surrounding an LTC6915. The bypass capacitor trace to the supply pins must be less than 0.2 inches (an X7R or X5R capacitor type is recommended). In single supply operation, connect the V⁻ pin to the analog ground plane and bypass the V⁺ pin.

Shutdown Modes

The IC has two shutdown modes, hardware shutdown and software shutdown. When SHDN is tied to V⁺, the IC is in hardware shutdown mode. During this shutdown mode, the gain setting digital interface (serial or parallel) and the main op amp are both disabled, thus the PGA dissipates very small supply current (see the Electrical Characteristic table). When SHDN is floating, an internal current source will pull it down to V⁻. The digital interface is turned on to read the gain setting codes. The IC is in normal amplification mode as long as the gain control code is other than 0000. If the gain control code is 0000, the IC operates in software shutdown mode, i.e., the main op amp is turned off so that the PGA dissipates less power. The DFN package does not have hardware shutdown.

Setting the Voltage at the REF Pin

The current coming out of the REF pin may affect the reference voltage at the REF pin (V_{REF}). If V_{REF} is set by a resistive divider then the V_{REF} voltage is a function of the V_{OUT} voltage (see Figure 5). In order to minimize the V_{REF} variations, the total resistance of R1 plus R2 should be much less than 32k (5k or less) or use a voltage reference to set V_{REF} .





TYPICAL APPLICATION

Multiplexing Two LTC6915's

Send a gain code of 0000 to one IC to set its output to a high impedance state and send a gain code other than 0000 to the second IC to set it for normal amplification. If both devices are ON, the 200Ω resistors protect the outputs. The sense pin connection maintains gain accuracy for loads 1k or greater.



Figure 6. A 2:1 Multiplexing Two LTC6915's with Daisy Chained Gain Control





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TYPICAL APPLICATION



Figure 7. Bridge Amplifier with Programmable Gain and Analog to Digital Conversion. (Standby Current Less than 100 μA)

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS					
LTC1043	Dual Precision Instrumentation Switched-Capacitor Building Block	Rail-to-Rail Input, 120dB CMRR					
LTC1100	Precision Zero-Drift Instrumentation Amplifier	Fixed Gains of 10 or 100, $10\mu V$ Offset, 50pA Input Bias Current					
LTC1101	Precision, Micropower, Single Supply Instrumentation Amplifier	Fixed Gain of 10 or 100, $I_S < 105 \mu A$					
LTC1167	Single Resistor Gain Programmable, Precision Instrumentation Amplifier	Single Gains Set Resistor, G = 1 to 10,000 Low Noise: 7.5nV/√Hz					
LTC1168	Low Power Single Resistor Gain Programmable, Precision Instrumentation Amplifiers	I _S = 530μA					
LTC1789-1	Single Supply, Rail-to-Rail Output, Micropower Instrumentation Amplifier	I _S = 80μA Max					
LTC2050	Zero-Drift Operational Amplifier	SOT-23 Package					
LTC2051	Dual Zero-Drift Operational Amplifier	MS8 Package					
LTC2052	Quad Zero-Drift Operational Amplifier	GN16 Package					
LTC2053	Rail-to-Rail Input and Output, Zero-Drift Instrumentation Amplifier with Resistor-Programmable Gain	MS8 Package, 10µV Max V _{OS} , 50nV/°C Max Drift					
LTC6800	Rail-to-Rail Input and Output, Instrumentation Amplifier with Resistor-Programmable Gain	MS8 Package, 100 μ V Max V _{OS} , 250nV/°C Max Drift					

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